MOSFETs Silicon N-Channel MOS

SSM6N68NU

1. Applications

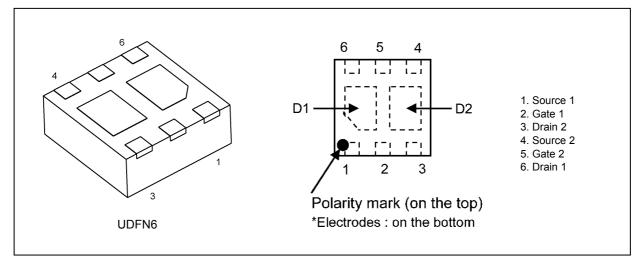
- Power Management Switches
- DC-DC Converters

2. Features

- (1) AEC-Q101 qualified (Note 1)
- (2) 1.8-V gate drive voltage.
- (3) Low drain-source on-resistance
 - $: R_{DS(ON)} = 84 \text{ m}\Omega \text{ (max)} (@V_{GS} = 4.5 \text{ V})$
 - $R_{\rm DS(ON)}$ = 117 mO (max) (@V_{\rm GS} = 2.5 V)
 - $R_{DS(ON)} = 180 \text{ m}\Omega \text{ (max)} (@V_{GS} = 1.8 \text{ V})$
- (4) HBM: 2-kV class

Note 1: For detail information, please contact to our sales.

3. Packaging and Pin Assignment



Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C) (Q1,Q2 Common)

Characteristics					Rating	Unit	
Drain-source voltage				V _{DSS}	30	V	
Gate-source voltage				V _{GSS}	12/-8		
Drain current (DC)			(Note 1)	Ι _D	4	А	
Drain current (pulsed)	·		(Note 1), (Note 2)	I _{DP}	10		
Power dissipation			(Note 3)	PD	1	W	
Power dissipation	(t <u>-</u>	≤ 10 s)	(Note 3)	PD	2		
Channel temperature				T _{ch}	150	°C	
Storage temperature				T _{stg}	-55 to 150		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Ensure that the channel temperature does not exceed 150 °C.
- Note 2: Pulse width (PW) \leq 10 ms, duty \leq 1 %
- Note 3: Device mounted on an FR-4 board.(total dissipation) (25.4 mm \times 25.4 mm \times 1.6 mm ,Cu pad: 645 mm²)
- Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.
- Note: The channel-to-ambient thermal resistance, R_{th(ch-a)}, and the drain power dissipation, P_D, vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

5. Electrical Characteristics

5.1. Static Characteristics (Unless otherwise specified, Ta = 25 °C)(Q1,Q2 Common)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	V _{DS} = 0 V, V _{GS} = 10/-8 V	_	_	±10	μA
Drain cut-off current		I _{DSS}	V _{DS} = 24 V, V _{GS} = 0 V	_	_	1	
Drain-source breakdown voltage		V _{(BR)DSS}	I _D = 1 mA, V _{GS} = 0 V	30	_	—	V
Drain-source breakdown voltage	(Note 1)	V _{(BR)DSX}	I _D = 1 mA, V _{GS} = -8 V	18	_	_	
Gate threshold voltage	(Note 2)	V _{th}	V _{DS} = 3 V, I _D = 1 mA	0.40	—	1.00	
Drain-source on-resistance	(Note 3)	R _{DS(ON)}	I_D = 2.0 A, V_{GS} = 4.5 V	—	67	84	mΩ
			I _D = 1.0 A, V _{GS} = 2.5 V	_	84	117	
			I _D = 0.5 A, V _{GS} = 1.8 V	_	112	180	
Forward transfer admittance	(Note 3)	Y _{fs}	V _{DS} = 3 V, I _D = 1 A	_	5.2	_	S

Note 1: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

Note 2: Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (1 mA for this device). Then, for normal switching operation, $V_{GS(ON)}$ must be higher than V_{th} , and $V_{GS(OFF)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$.

Take this into consideration when using the device.

Note 3: Pulse measurement.

5.2. Dynamic Characteristics (Unless otherwise specified, Ta = 25 °C)(Q1,Q2 Common)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance		C _{iss}	V _{DS} = 15 V , V _{GS} = 0 V, f = 1 MHz	_	129	_	pF
Reverse transfer capacitance		C _{rss}		—	13	_	
Output capacitance		C _{oss}		_	34	_	
Switching time (turn-on time)	(Note 1)	t _{on}	V _{DD} = 15 V, I _D = 0.5 A,	_	26	_	ns
Switching time (turn-off time)	(Note 1)	t _{off}	V_{GS} = 0 to 2.5 V, R_{G} = 4.7 Ω	_	9	_	

Note 1: See chapter 5.3

5.3. Switching Time Test Circuit

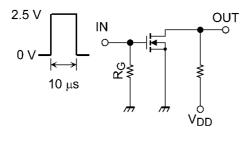


Fig. 5.3.1 Switching Time Test Circuit

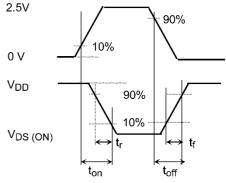


Fig. 5.3.2 Input Waveform/Output Waveform

5.4. Gate Charge Characteristics (Unless otherwise specified, T_a = 25 °C) (Q1,Q2 Common)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	V _{DD} = 15 V, I _D = 4 A,	—	1.8	—	nC
Gate-source charge 1	Q _{gs1}	V _{GS} = 4.5 V	_	0.3	_	
Gate-drain charge	Q _{gd}		_	0.8	_	

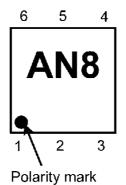


5.5. Source-Drain Characteristics (Unless otherwise specified, T_a = 25 °C) (Q1,Q2 Common)

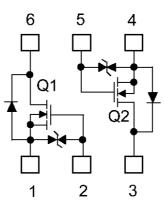
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage ((Note 1)	V_{DSF}	I _D = -4 A, V _{GS} = 0 V		-0.86	-1.2	V

Note 1: Pulse measurement.

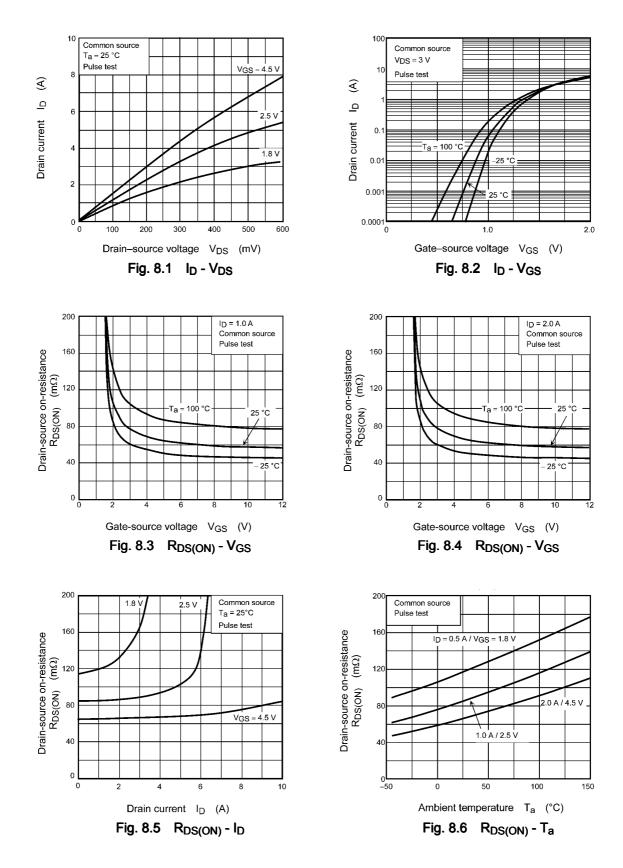
6. Marking

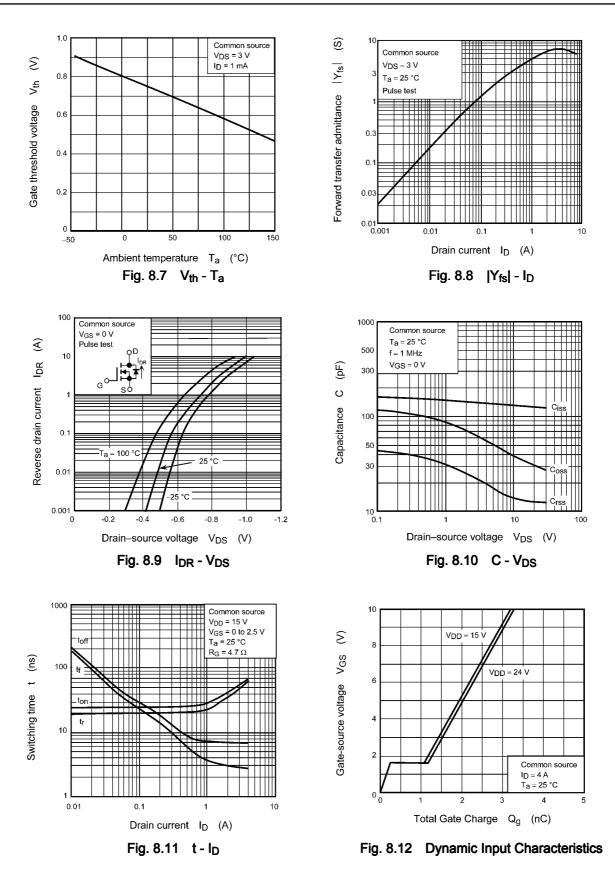


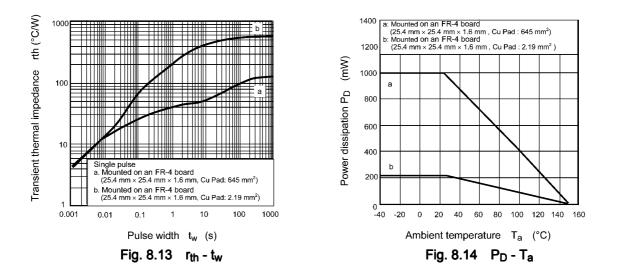
7. Internal Equivalent Circuit



8. Characteristics Curves (Q1,Q2 Common) (Note)







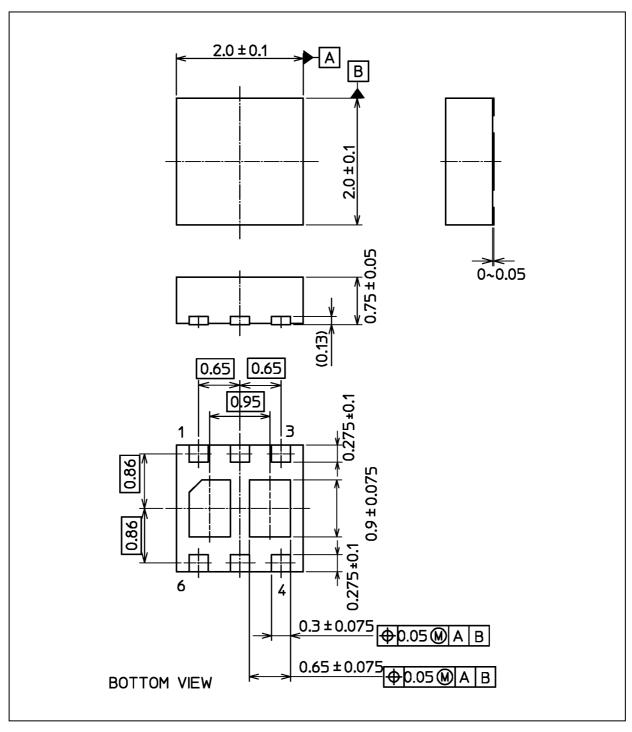
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



SSM6N68NU

Package Dimensions

Unit: mm



Weight: 8.5 mg (typ.)

Package Name(s)

Nickname: UDFN6

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